

QE for Capacitive Touch[RA,RL78,Synergy] V1.4.0

Release Note

Thank you very much for using the QE for Capacitive Touch[RA,RL78,Synergy] V1.4.0.

This release note covers product installation, restrictions, and so on. Please read this document before using the product.

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1. About QE for Capacitive Touch

1.1 Summary

QE for Capacitive Touch[RA,RL78,Synergy] is an assistance tool for applications and operates under the e² studio integrated development environment. In the development of an embedded system based on an RA family, RL78 family or Renesas Synergy MCU that incorporates the capacitive touch sensing unit (hereafter the CTSU), this product facilitates the easy initialization of touch interfaces and tuning of their sensitivity, thus reducing development times.

To use QE for Capacitive Touch[RA,RL78,Synergy], you will first need to add a project for the RA family, RL78 family or Renesas Synergy MCU and the capacitive touch sensor-related CTSU driver and Touch middleware. In addition, QE for Capacitive Touch[RA,RL78,Synergy] can easily set pin assignment for use with capacitive touch sensors in conjunction with Smart Configurator.

1.2 Functions

The three functions below make it easy to develop applications that involve capacitive touch sensors.

1. Creating touch interface configurations
2. Tuning
3. Monitoring and parameter adjustment

1.3 New Functions

1.3.1 Renesas Synergy is now supported

This product can now be used in a project for an Renesas Synergy device. For details, please refer to the help for QE for Capacitive Touch[RA,RL78,Synergy] V1.4.0.

1.4 Supported Environment

Windows 8.1, and Windows 10

Renesas e² studio 2021-04 (or later)

* If you are using a version of the e² studio earlier than 2021-04, please update it to 2021-04 or later.

1.5 Supported Microcontrollers

- RA Family (only MCUs that incorporate the CTSU)
 - RA2A Series: RA2A1
 - RA2E Series: RA2E1
 - RA2L Series: RA2L1
 - RA4M Series: RA4M1
 - RA4W Series: RA4W1
 - RA6M Series: RA6M1, RA6M2, RA6M3, RA6M4
- RL78 Family (only MCUs that incorporate the CTSU)
 - RL78/G23
- Renesas Synergy (only MCUs that incorporate the CTSU)
 - S1 Series: S124, S128, S1JA
 - S3 Series: S3A1, S3A3, S3A6, S3A7
 - S5 Series: S5D3, S5D5, S5D9
 - S7 Series: S7G2

1.6 Supported Software

- Driver and middleware for capacitive touch sensor
 - RA Flexible Software Package (FSP)
 - CTSU driver: r_ctsu V2.2.0 (or later)
 - Touch middleware: rm_touch V2.2.0 (or later)
 - RL78 Software Integration System
 - CTSU driver: r_ctsu V1.00 (or later)
 - Touch middleware: rm_touch V1.00 (or later)
 - Renesas Synergy Software Package (SSP)
 - CTSU driver: r_ctsuv2 V2.0.0 (or later)
 - Touch framework: sf_touch_ctsuv2 V2.0.0 (or later)

2. Installation and Uninstallation

2.1 Installing This Product

Use either of the following procedure to install this product.

2.1.1 Install from the "Renesas Software Installer" menu of e2 studio

1. Start e² studio.
2. Select the "Renesas Views" – "Renesas Software Installer" menu of e² studio to open the "Renesas Software Installer" dialog box.
3. Select the "Renesas QE" and click the "Next>" button
4. Select the "QE for Capacitive Touch[RA,RL78,Synergy] (v1.4.0)" check box, and click the "Finish" button.
5. Check that the "Renesas QE for Capacitive Touch[RA,RL78,Synergy]" check box is selected in the "Install" dialog box, and click the "Next>" button.
6. Check that the "Renesas QE for Capacitive Touch[RA,RL78,Synergy]" check box is selected as the target of installation, and click the "Next>" button.
7. After confirming the license agreements, if you agree to the license, select the "I accept the terms of the license agreements" radio button, and click the "Finish" button.
8. If the dialog of the trust certificate is displayed, check that certificate, and click the "OK" button to continue installation.
9. When prompted to restart e² studio, restart it.
10. Start this product from the "Renesas Views" - "Renesas QE" menu of e² studio. For details about how to use this product, see the "Help" menu of e² studio.

2.1.2 Install using QE (zip file) downloaded from the Renesas website

1. Activate the e² studio.
2. Click on "Help", and then click on the "Install New Software..." menu item to open the "Install" dialog box.
3. Click on the "Add..." button to open the "Add Repository" dialog box.
4. Click on the "Archive..." button, select the installation file (zip file) in the opened file selection dialog box, and then click on the "Open" button.
5. Click on the "OK" button in the "Add Repository" dialog box.
6. Expand the "Renesas QE" item shown in the "Install" dialog box, select the "Renesas QE for Capacitive Touch[RA,RL78,Synergy]" check box, and then click on the "Next>" button.
* If you check off the "Contact all update sites during install to find required software" checkbox, you can shorten the installation time.
7. Confirm that the installation target is "Renesas QE for Capacitive Touch[RA,RL78,Synergy]", and then click on the "Next>" button.
8. After checking the license, select the "I accept the terms of the license agreements" radio button if you agree it, and then click on the "Finish" button.
9. When the dialog box for selecting a trusted certificate appears, check the displayed certificate, and then click on the "OK" button to continue installation.
10. Restart the e² studio by following the instructions on the screen.
11. Start this product from the "Renesas Views" - "Renesas QE" menu of the e² studio.
For details about how to use this product, see the "Help" menu of the e² studio.

2.2 Updating This Product

If you have already installed this product, you can update it in the same way as the procedure for installation.

2.3 Uninstalling This Product

Follow the procedure below to uninstall this product.

1. Start the e² studio.
2. Select "Help -> About e² studio" to open the "About e² studio" dialog box.
3. Click the "Installation Details" button to open the "e² studio Installation Details" dialog box.
4. Select "Renesas QE for Capacitive Touch[RA,RL78,Synergy]" displayed on the "Installed Software" tabbed page and click on the "Uninstall..." button to open the "Uninstall" dialog box.
5. Check the displayed information and click on the "Finish" button.
6. When you are prompted to restart the e² studio, restart it.

3. Notes / Restrictions

3.1 Usage Considerations

Please pay attention to the following items.

3.1.1 Notes on Tuning

1. If there are multiple debugging configurations in the target project, automatic tuning may fail. Delete debugging configurations that are not in use.
2. When the "Automatic Tuning Processing" dialog box is waiting for key input, pressing the "Cancel" / "Help" button is not possible.

3.2 Functional Restrictions

The following restriction applies to QE for Capacitive Touch[RA,RL78,Synergy] V1.4.0.

3.2.1 Restriction on Monitoring

1. (For only RA family)
A build error will be occurred, when you set enabled a monitoring function via serial communication using QE V1.1.0 (or later) and FSP V3.0.0. (It will be improved on FSP V3.1.0.)

If all of the following conditions are met, an error will occur at build time.

- Use FSP V3.0.0 for RA family.
- Set "Enabled" on the "Support for QE monitoring using UART" property for the rm_touch module.
- Output parameter files by QE V1.1.0 or later.

[Workaround 1]

Open the rm_touch.c file with an editor and modify lines 2164 to 2165 as follows.

Before:

```
g_touch_monitor_buf[index++] = g_touch_version.code_version_minor;  
g_touch_monitor_buf[index++] = g_touch_version.code_version_major;
```

After:

```
g_touch_monitor_buf[index++] = 0x00;  
g_touch_monitor_buf[index++] = 0x01;
```

[Workaround 2]

Update FSP to V3.1.0 or later.

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	May.28.21	-	First edition issued.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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